



# Fiducial Mark Interoperability TF Report

As of February 24, 2016

# TF Leadership (No Change)

- H. Tsunobuchi / KEYENCE  
Traceability Committee
- T. Nakai / SUMCO  
Silicon Wafer Committee
- S. Mashiro / Tokyo Electron  
Physical Interface and Carrier Committee
- S. Masuchi / DISCO  
Assembly and Package Committee
- M. Matsuda / Hitachi Kokusai  
Information and Control Committee

# Recent TF activity

- The latest TF meeting on Nov. 18, 2015
- T7 issues
  - SNARF 5890
    - Delete all position specifications from SEMI T7 because position specifications are also described on SEMI M1 and other related Silicon Standard.
  - Document 5890
    - Submitting to 2015 Cycle 7, passed with editorial changes at JA TC Chapter meeting of Traceability TC on Dec. 18, 2015, and passed A&R.
    - Waiting for publication.
- Others
  - Assembly and Packaging: Discussing backend alignment issues with introducing fiducial mark wafer.
  - TF leaders to start discussion about disbanding this TF if the TF doesn't have further activity.

# Next Meeting

- TBD